**3GPP TSG RAN WG1 #102-e R1-200xxxx**

**e-Meeting, August 17th – 28th, 2020**

**Agenda item: 8.1.2.1**

**Source:** **Moderator (Nokia, Nokia Shanghai Bell)**

**Title: Summary of Enhancements for Multi-TRP URLLC for PUCCH and PUSCH**

**Document for: Discussion and Decision**

# Introduction

This document summarizes remaining issues on M-TRP PUCCH and PUSCH enhancement to collect further inputs, and the more detailed summary after the phase 2 email discussion [102-e-NR-feMIMO-03] can be found in [R1-2007182](https://www.3gpp.org/ftp/tsg_ran/WG1_RL1/TSGR1_102-e/Inbox/R1-2007182.zip).

In here, Section 2.1 contains offline agreements which can be endorsed by the chairman, please comment if that is not the case. Section 2.2 summarizes the updated proposals based on phase 2 email discussion.

# Summary of PUCCH/PUSCH proposals (based on R1-2007182)

## Offline Agreements

The offline agreements that do not have any objections/concerns are summarized as follows,

**Offline Agreement 2:** To improve reliability and robustness for PUCCH using multi-TRP and/or multi-panel, consider all PUCCH formats.

**Offline Agreement 3:** To enable TDMed PUCCH ~~repetition~~transmission with different beams, support configuring/activating of multiple PUCCH Spatial Relation Info. RAN1 shall further study the exact schemes considering the following aspects,

* Method of configuration/activation of multiple spatial relation info
* Use of the same PUCCH resource or different PUCCH resource for PUCCH ~~repetition~~transmission
* Mapping between PUCCH repetition/symbol and spatial relation info among multiple PUCCH repetitions / multiple PUCCH symbols.

**Offline Agreement 4:** For configuration/indication of the number of PUCCH repetitions, RAN1 shall further study the following,

* Alt.1: Use Rel-15 like framework
* Alt.2: Dynamic indication of the number of PUCCH repetitions

**Offline Agreement 5:** For multi-TRP PUCCH transmission, further investigate required power control enhancement.

**Offline Agreement 9:** Further study M-TRP CG PUSCH reliability enhancements in Rel-17.

Comment if you have any objections (for the above offline agreements).

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| **Company** | **Comments** |
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## Remaining Proposals for Phase 3 discussion

#### Proposal 1: FL comments after phase 2

Based on comments received in phase 2 email discussion, QC and Samsung suggesting changes to proposal 1 (section 3.1, [1]).

QC mentioned that “if beam hopping is used within one PUCH resources, and assuming that we use similar procedures as frequency hopping, it is not technically a repetition”. This is agreed by all other companies (except Samsung). The suggested changes are taken into account in the latest proposal.

Samsung mentioned that “wording inter-/intra-slot repetition is restricted for a single PUCCH resource case. However, we think that using multiple PUCCH resources with the same UCI can be also treated as repetition”. Oppo, Xiaomi, and Spreadtrum seem to be Ok with either QC suggestion or Samsung suggestion. From the FL perspective, mentioning of “UCI repetition” (suggested by Samsung) may not fully address the issue of single PUCCH or multiple PUCCH resources. Also, please note that updated proposal 3 is capturing all different aspects, and proposal 1 only focuses on inter and intra slot scenarios. To solve the concern raised by Samsung, a note is included in the updated proposal (changes to the earlier version is marked with red).

**Proposed offline Agreement 1:** Support TDMed PUCCH ~~repetition~~ scheme(s) to improve reliability and robustness for PUCCH using multi-TRP and/or multi-panel. Study the following alternatives,

* Alt.1: supporting both inter-slot repetition and intra-slot repetition / intra-slot beam hopping.
* Alt.2: supporting only inter-slot repetition
* Note: It is not precluded to study the use of multiple PUCCH resources to repeat the same UCI in both inter-slot repetition and intra-slot repetition.

Comment if you have any concerns,

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| **Company** | **Comments** |
| Apple | We think some clarification of the difference between “intra-slot repetition” and “intra-slot beam hopping” could be helpful. |
| Samsung | Support the FL proposal. |
| DOCOMO | We are fine with the proposal. But we agree with Apple that it is better to clarify the meaning of “intra-slot beam hopping”. |
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#### Proposal 6: FL comments after phase 2

All companies (except Samsung) support the proposed offline agreement below. Samsung suggests considering single DCI and multi-DCI with equal priority. There is no priority mentioned in the proposal and support of multi-DCI based approach needs more investigation from other companies (majority). Therefore, this proposal reflects the majority understanding of this meeting.

**Proposed offline Agreement 6:** For M-TRP PUSCH reliability enhancement, support single DCI based PUSCH transmission/repetition scheme(s).

* Further study multi-DCI based PUSCH transmission/repetition scheme(s) to identify potential gains and required enhancements.

Comment if you have any concerns,

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| **Company** | **Comments** |
| Samsung | We are also fine with the proposal considering single DCI based PUSCH transmission/repetition scheme(s) first. |
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#### Proposal 7: FL comments after phase 2

Based on comments received so far, a majority of companies are fine with the proposal. However, there are some comments from LG, HW, Futurewei suggesting another change to the proposal (to study PUSCH transmission without repetition further). From the FL perspective, the update looks reasonable, and the proposal 7 is updated based on HW suggestion.

**Proposed offline Agreement 7:** For single DCI based M-TRP PUSCH reliability enhancement, support TDMed PUSCH repetition scheme(s) based on Rel-16 PUSCH repetition Type A and Type B.

* Further study PUSCH transmission without repetition as a potential candidate M-TRP PUSCH scheme

Comment if you have any concerns,

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| **Company** | **Comments** |
| Samsung | Support the FL proposal. |
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#### Proposal 8: FL comments after phase 2

All companies support the proposal. However, HW has a suggestion to change the wording of SRI(s) to beams (last sub-bullet). Suggestion looks reasonable, and the proposal is updated as below,

**Proposed offline agreement 8**: To support single DCI based M-TRP PUSCH repetition scheme(s), up to two beams are supported. RAN1 shall further study the details considering,

* Codebook based and non-codebook based PUSCH
* Enhancements on SRI/TPMI/power control parameters/TA/any other
* Mapping between PUSCH repetitions and ~~SRI(s)~~beams

Comment if you have any concerns,

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| **Company** | **Comments** |
| Apple | We think TA should be removed. |
| Samsung | In addition to beams, mapping between PUSCH repetitions and power control parameters/TA/any other can be also considered. |
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# 3 References

[R1-2007182](https://www.3gpp.org/ftp/tsg_ran/WG1_RL1/TSGR1_102-e/Inbox/R1-2007182.zip) Summary of AI:8.1.2.1 Enhancements for Multi-TRP URLLC for PUCCH and PUSCH Nokia, NSB